TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

# 2SK2991

#### DC-DC Converter Relay Drive and Motor Drive Applications

- Low drain-source ON resistance  $: RDS (ON) = 1.35 \Omega (typ.)$
- High forward transfer admittance  $|Y_{fs}| = 4.0 \text{ S (typ.)}$
- Low leakage current  $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 500 \ V)$
- Enhancement mode  $: V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ ID} = 1 \text{ mA})$

#### Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	500	V	
Drain-gate voltage (R	<sub>GS</sub> = 20 kΩ)	V <sub>DGR</sub>	500	V	
Gate-source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC (Note 1)	۱ <sub>D</sub>	5	А	
	Pulse (Note 1)	I <sub>DP</sub>	20	A	
Drain power dissipation	n (Tc = 25°C)	PD	50	W	
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	180	mJ	
Avalanche current		I <sub>AR</sub>	5	A	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

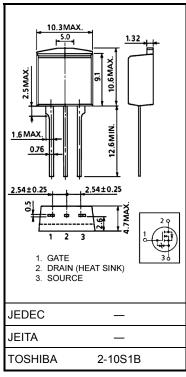
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.5	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	83.3	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

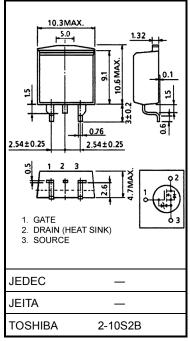
Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 12.2 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



Weight: 1.5 g (typ.)



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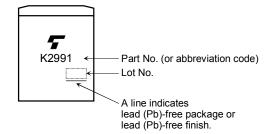
## Electrical Characteristics (Ta = 25°C)

Charae	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μA
Gate-source br	eakdown voltage	V (BR) GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	100	μA
Drain-source bi	reakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.5 A	_	1.35	1.50	Ω
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.5 A	2.5	4.0	_	S
Input capacitant	ce	C <sub>iss</sub>		_	780	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	60	_	pF
Output capacitance		C <sub>oss</sub>			200	_	
Switching time	Rise time	t <sub>r</sub>	$v_{GS} \stackrel{10V}{}_{0V} \prod \qquad I_{D} = 2.5A \circ V_{OUT}$	_	12	_	
	Turn-on time	t <sub>on</sub>		_	25	_	ns
	Fall time	t <sub>f</sub>		_	15	_	
	Turn-off time	t <sub>off</sub>	$\begin{array}{c} V_{DD} \rightleftharpoons 225V\\ \text{Duty} \leq 1\%, \ t_W = 10 \mu s \end{array}$	_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	17	_	
Gate-source charge		Q <sub>gs</sub>	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		11	_	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>			6	_	

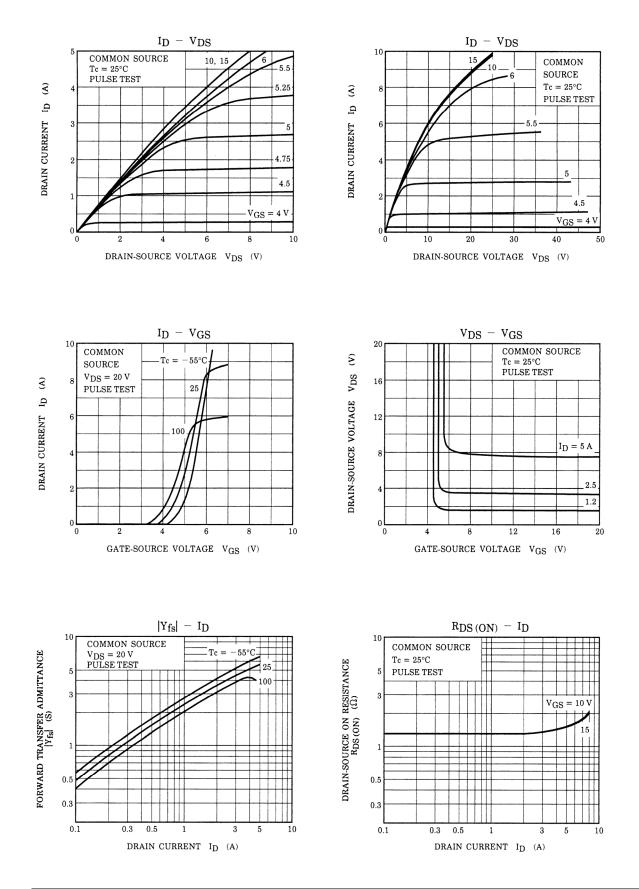
## Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	5	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	_	_	20	А
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V, dI <sub>DR</sub> / dt = 100 A / μs	_	1400	_	ns
Reverse recovery charge	Q <sub>rr</sub>		_	9	_	μC

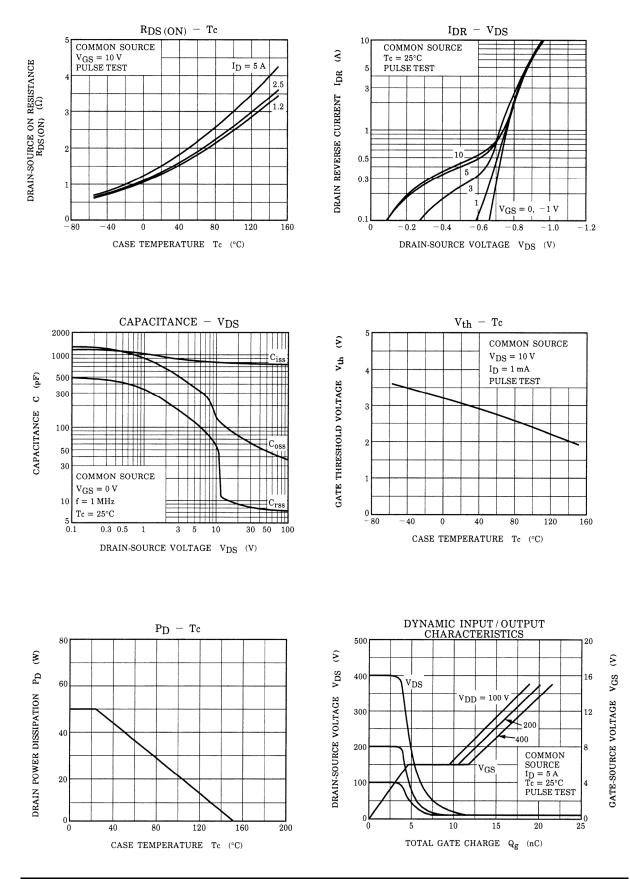
## Marking

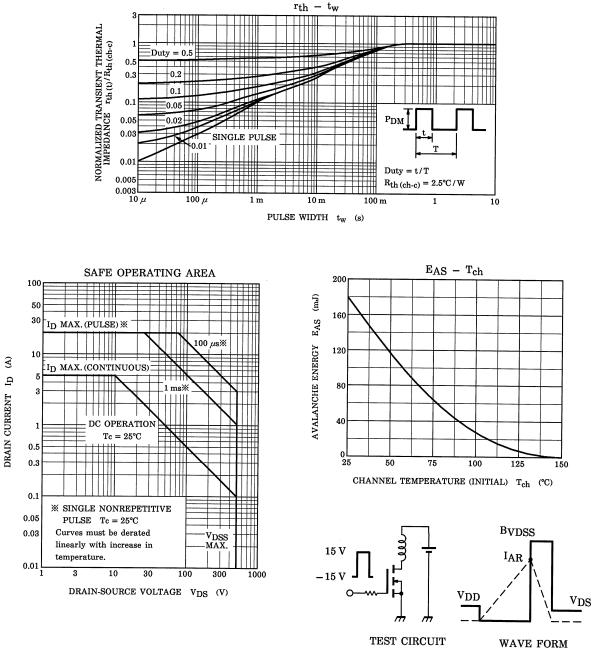


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 $\begin{array}{ll} \mathrm{R}_{\mathrm{G}} = 25 \ \Omega \\ \mathrm{V}_{\mathrm{DD}} = 90 \ \mathrm{V}, \ \mathrm{L} = 12.2 \ \mathrm{mH} \end{array} \qquad \mathrm{E}_{\mathrm{AS}} = \frac{1}{2} \cdot \mathrm{L} \cdot \mathrm{I}^2 \cdot \left( \frac{\mathrm{B} \mathrm{V}\mathrm{D}\mathrm{SS}}{\mathrm{B} \mathrm{V}\mathrm{D}\mathrm{SS} - \mathrm{V}\mathrm{D}\mathrm{D}} \right) \end{array}$ 

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